

(٧)	Preliminary	Specifications
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() Final Specifications

Module	13.3" HD Color TFT-LCD
Model Name	B133XW01 V3 (H/W:3A)
Note (🗭)	LED Backlight with driving circuit design

Customer	Date
Checked & Approved by	Date
Note: This Specification is a notice.	subject to change without

Approved by	Date				
Bonnie Chen	9 th Mar, 2009				
Prepared by					
<u>Vicki Chai</u>	9 th Mar, 2009				
NBBU Marketing Division / AU Optronics corporation					



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Record of Revision

Ver	Version and Date		Old description	New Description	Remark
0.1	2008/10/31	All	First Edition for Customer		
0.2	0.2 2009/03/04 5		Power consumption = TBD	Power consumption = 4.8W max	
		5-6	Response time = 12ms max	Response time = 16ms max	
		6	Cross talk = TBD	Cross talk = 4%	
			Color spec = TBD	Color spec updated	
		15	P _{LED} = TBD	P _{LED} = 3.8W max	
		19	LED Power Supply 7V-20V	LED Power Supply 6V-21V	
		20	Rear view drawing	Rear view drawing updated	
		25	LED Power Supply 7V-20V	LED Power Supply 6V-21V	
		28-29	2D drawing	2D drawing updated	
	30-31		TBD	Shipping and packing updated	
	32-34		TBD	EDID added	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 11) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



2. General Description

B133XW01 V2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the High Definition (1366(H) x 768(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B133XW01 V2 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit		Specifications				
Screen Diagonal	[mm]	336.6 (13.25W")					
Active Area	[mm]	293.42 X	164.97				
Pixels H x V		1366x3(F	RGB) x 768				
Pixel Pitch	[mm]	0.2148X0).2148				
Pixel Format		R.G.B. Ve	ertical Stripe				
Display Mode		Normally	White				
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]		220 typ. (5 points average) 187 min. (5 points average)				
Luminance Uniformity		1.25 max. (5 points)					
Contrast Ratio		400 typ					
Response Time	[ms]	8 typ / 16 Max					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	4.8W					
Weight	[Grams]	315 max.					
Physical Size			L	W	Т		
1 Trysloat Olzo	[mana]	Max	306.8	193.83	3.8		
	[mm]	Typical	-	-	-		
		Min	-	-	-		
Electrical Interface		1 channel LVDS					
Glass thickness	Glass thickness [mm]				0.5		
Surface Treatment		Anti-Glare, Hardness 3H					



Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

Item	Unit	Conditions	Min.	Тур.	Max.	Note
White Luminance (ILED=20mA)	[cd/m ²]	5 points average	187	220	-	1, 4, 5.
	[degree]	Horizontal	-	45	-	4, 9
Viewing Angle	[degree]	(Right) CR = 10 (Left)	-	45	-	
Viewing Angle	[degree]	Vertical	-	15	-	
	[degree]	(Upper) CR = 10 (Lower)	-	35	-	
Luminance		5 Points	-	-	1.25	1, 3, 4
Uniformity		13 Points	-	-	1.5	2, 3, 4
CR: Contrast Ratio			300	400	-	4, 6
Cross talk	%				4	4, 7
Response Time	[msec]	Rising + Falling	-	8	16	
		Red x	0.555	0.585	0.615	
		Red y	0.305	0.335	0.365	
		Green x	0.300	0.330	0.360	
		Green y	0.545	0.575	0.605	4, 9
Chromaticity of color		Blue x	0.125	0.155	0.185	
Coordinates (CIE 1931)		Blue y	0.100	0.130	0.160	
(3.2 1001)		White x	0.283	0.313	0.343	
		White y	0.299	0.329	0.359	



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

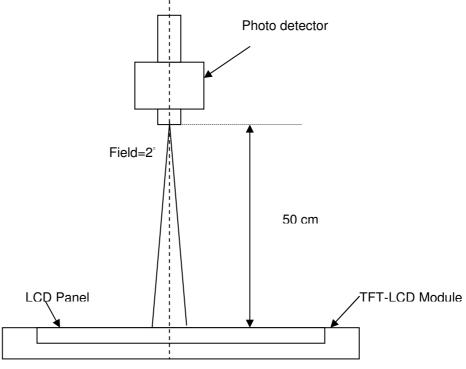
0		Maximum Brightness of five points
δ _{w5} =		Minimum Brightness of five points
2		Maximum Brightness of thirteen points
$\delta_{\text{W13}} =$	= '	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

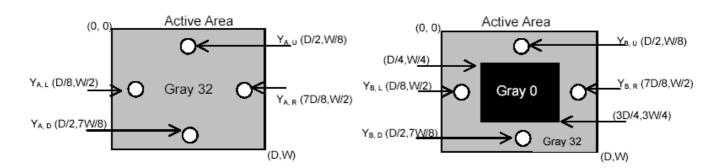
Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)

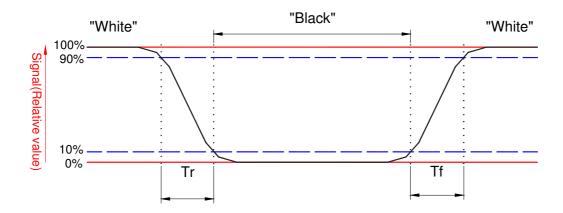


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Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

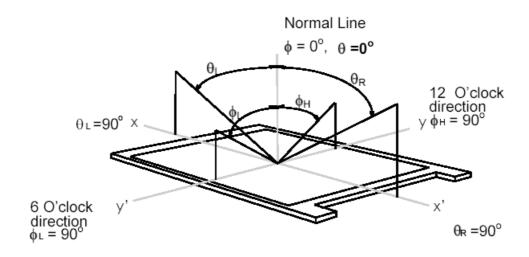




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Note 9. Definition of viewing angle

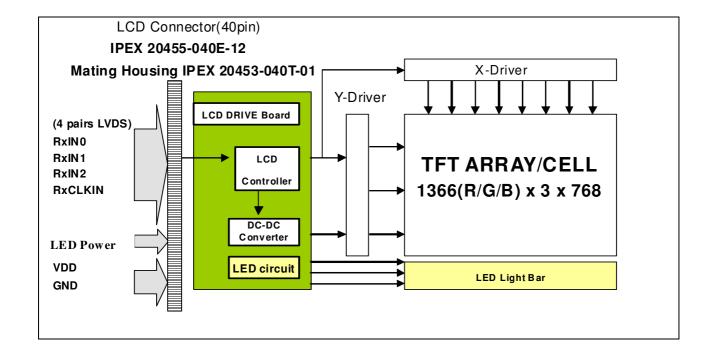
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 13.3 inches wide Color TFT/LCD Module:





4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	10	90	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	10	90	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).

5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

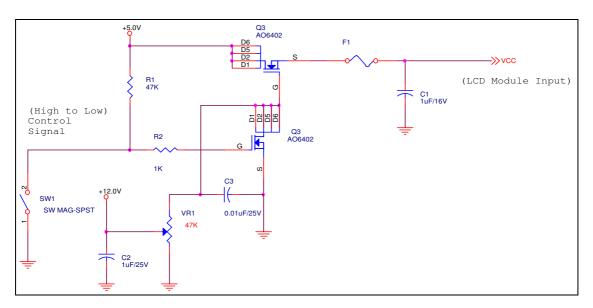
Input power specifications are as follows;

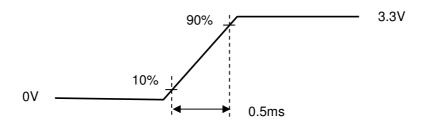
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	0.9	[Watt]	Note 1/2
IDD	IDD Current	-	-	300	[mA]	Note 1/2
IRush	Inrush Current	1	ı	2000	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time



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5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

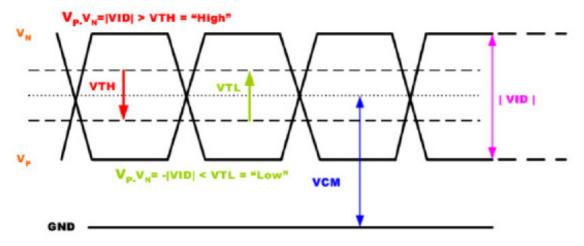
It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform

Single-end Signal





LED Parameter guideline for LED driving selection

Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V_{F}	3.0	3.2	3.4	[Volt]	(Ta=25°C)
LED Forward Current	I _F	-	20	30	[mA]	(Ta=25°C)
LED Power consumption	P_{LED}	-	-	3.8	[Watt]	(Ta=25°C) Note 1
LED Life-Time	N/A	10000	-	-	Hour	(Ta=25°C) I _F =20 mA Note 2
Output PWM frequency	F _{PWM}	100	200	20K	Hz	
Duty ratio		5		100	%	

Note 1: Calculator value for reference $P_{LED} = IF \times VF \times LED(Qty)$

Note 2: The LED life-time define as the estimated time to 50% degradation of minimum specification luminance.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1		2			13	36	5	13	866	5
1st Line	R G	B R	G	В		R	G	В	R	G	В
	,						`				
	`		1		t.		1			ı	
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					•		•				
	``		1		1 1		`			1	
	```				· 1		`				
768th Line	R G	B R	G	В		R	G	В	R	G	В



## 6.2 The input data format

RxCLKIN		/
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1
RxIN2	DE VS HS B5 B4	B3 B2

Signal Name	Description	
R5 R4 R3 R2 R1 R0	Red Data 5 (MSB) Red Data 4 Red Data 3 Red Data 2 Red Data 1 Red Data 0 (LSB)	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
	Red-pixel Data	
G5 G4 G3 G2 G1 G0	Green Data 5 (MSB) Green Data 4 Green Data 3 Green Data 2 Green Data 1 Green Data 0 (LSB)	Green-pixel Data Each green pixel's brightness data consists of these 6 bits pixel data.
	Green-pixel Data	
B5 B4 B3 B2 B1 B0	Blue Data 5 (MSB) Blue Data 4 Blue Data 3 Blue Data 2 Blue Data 1 Blue Data 0 (LSB) Blue-pixel Data	Blue-pixel Data Each blue pixel's brightness data consists of these 6 bits pixel data.
RxCLKIN	Data Clock	The typical frequency is 72 MHZ The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



# 6.3 Integration Interface and Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	AVDD	PowerSupply,3.3V(typical)
3	AVDD	PowerSupply,3.3V(typical)
4	DVDD	DDC 3.3Vpower
5	NC	No Connection (Reserve)
6	SCL	DDC Clock
7	SDA	DDC Data
8	Rin0-	-LVDS differential data input(R0-R5,G0)
9	Rin0+	+LVDS differential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDS differential data input(G1-G5,B0-B1)
12	Rin1+	+LVDS differential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDS differential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDS differential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDS differential clock input
18	ClkIN+	+LVDS differential clock input
19	GND	Ground-Shield
20	NC	No Connection (Reserve)
21	NC	No Connection (Reserve)
22	GND	Ground-Shield
23	NC	No Connection (Reserve)
24	NC	No Connection (Reserve)
25	GND	Ground-Shield
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)
28	GND	Ground-Shield
29	NC	No Connection (Reserve)
30	NC	No Connection (Reserve)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)



35	PWM	System PWM Signal Input
36	LED_EN	LED enable pin(+3V Input)
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply 6V-21V
39	VLED	LED Power Supply 6V-21V
40	VLED	LED Power Supply 6V-21V

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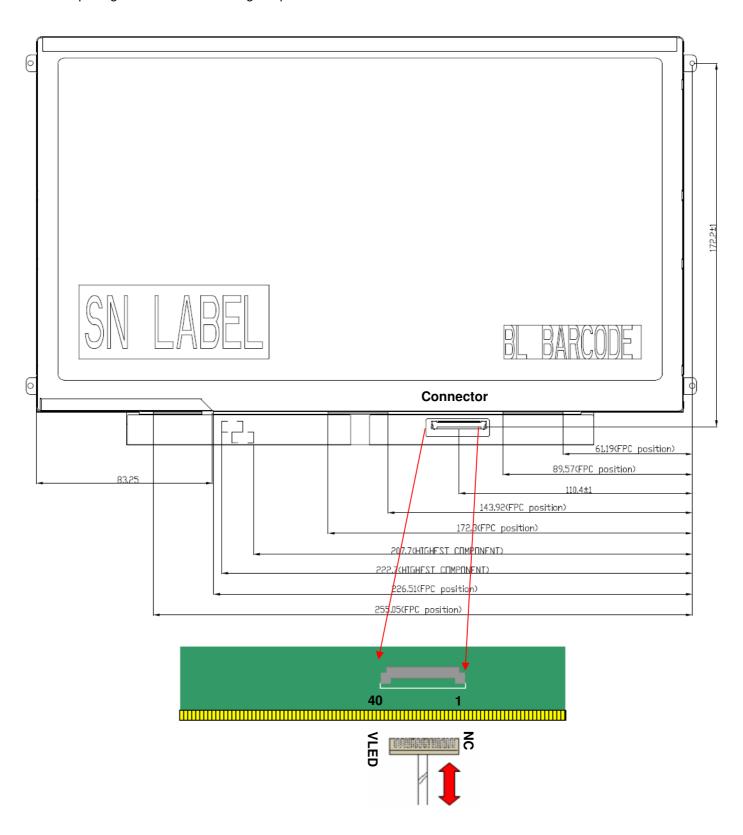


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Note1: Viewing from rear of the module

Note2: Start from right side

Note3: Input signals shall be low or High-impedance state when VDD is off.

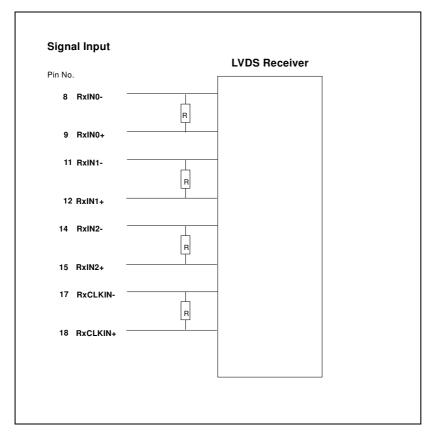




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Internal circuit of LVDS inputs are as following.

The module uses a 100ohm resistor between positive and negative data lines of each receiver input





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### 6.4 Interface Timing

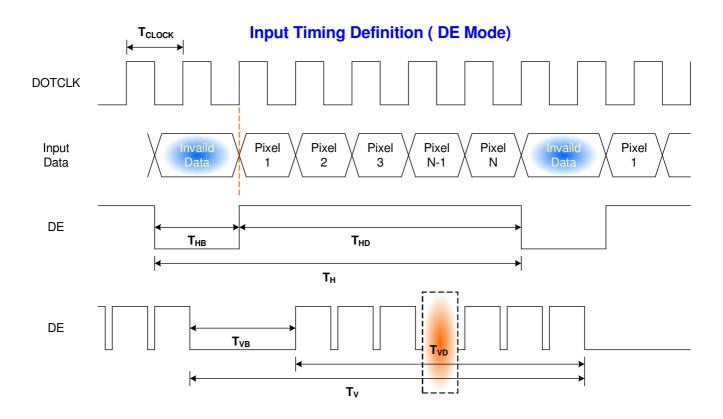
### 6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

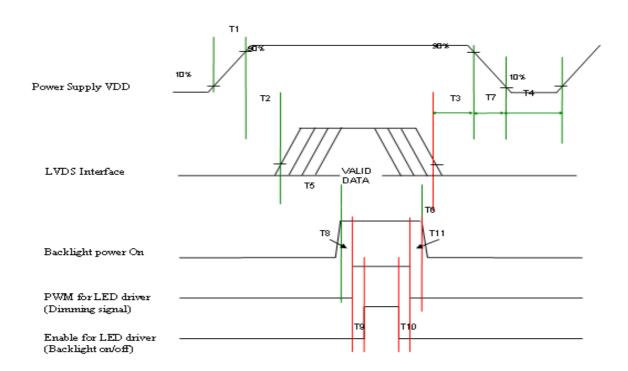
Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-	50	60	-	Hz
Clock frequency		1/ T _{Clock}	•	72	•	MHz
	Period	T _V	780	803	-	
Vertical	Active	T _{VD}		768	-	$T_Line$
Section	Blanking	T _{VB}	12	35	-	
	Period	T _H	1426	1494	-	
Horizontal	Active	<b>T</b> _{HD}	-	1366	-	T _{Clock}
Section	Blanking	<b>T</b> _{HB}	60	128	-	

Note: DE mode only

## 6.4.2 Timing diagram



## 6.5 Power ON/OFF Sequence



Doromotor		Value		Unito
Parameter	Min.		Max.	Units
T1	0.5	-	10	(ms)
T2	5	-	50	(ms)
T3	0.5	-	50	(ms)
T4	400	-	-	(ms)
T5	200	-	-	(ms)
T6	200	-	-	(ms)
T7	0	-	10	(ms)
T8	10			(ms)
T9	10			(ms)
T10	0			(ms)
T11	10			(ms)



## 7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

### 7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12 or compatible
Mating Housing/Part Number	IPEX 20453-040T-01 or compatible



# 8. LED Driving Specification

## **8.1 Connector Description**

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

## 8.2 Pin Assignment

PIN#	Signal Name	Description
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	PWM	System PWM Signal Input
36	LED_EN	LED enable pin(+3V Input)
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply 6V-21V
39	VLED	LED Power Supply 6V-21V
40	VLED	LED Power Supply 6V-21V

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### 9. Vibration and Shock Test

### 9.1 Vibration Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

## 9.2 Shock Test Spec:

**Test Spec:** 

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side



## 10. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 300h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

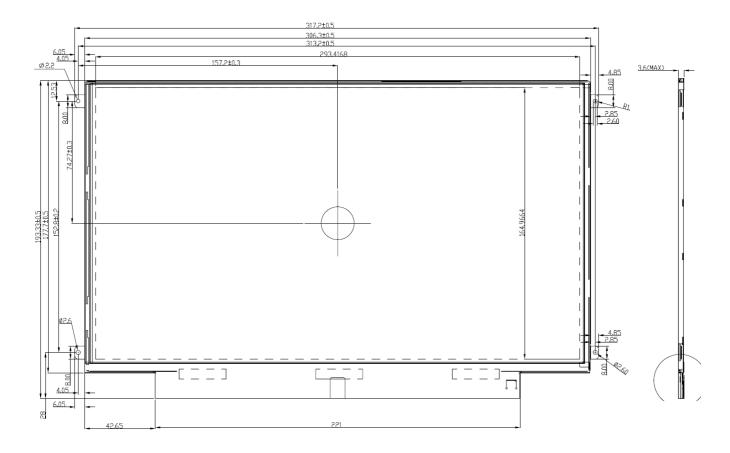
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



### 11. Mechanical Characteristics

## 11.1 LCM Outline Dimension

### Front view



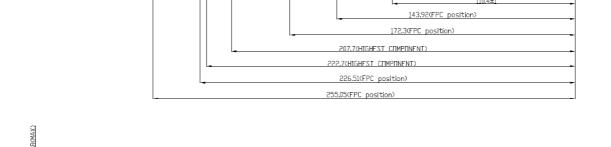
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9)

61.19(FPC position)

89,57(FPC position)



## 12. Shipping and Package

## 12.1 Shipping Label Format



Manufactured YY/WW Model No: B133XW01 V3 **AU Optronics** MADE IN CHINA (S1)

H/W: 3A F/W:1

E204356

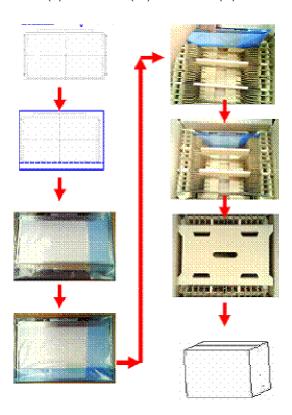


RoHS

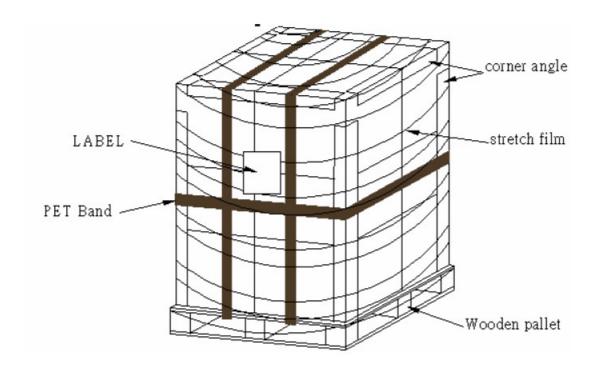


## 12.2 Carton package

The outside dimension of carton: 437 (L) mm x 359 (W) mm x 285 (H) mm



# 12.3 Shipping package of palletizing sequence





13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	2C	00101100	44	
0B	hex, LSB first	13	00010011	19	
0C	32-bit ser#	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	12	00010010	18	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	1D	00011101	29	
16	Max V image size (rounded to cm)	10	00010000	16	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	F9	10111010	186	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	D5	01100101	101	
1B	Red x (Upper 8 bits)	95	10011011	155	
1C	Red y/ highER 8 bits	55	01011001	89	
1D	Green x	54	01010100	84	
1E	Green y	93	10011110	158	
1F	Blue x	27	00100110	38	
20	Blue y	21	00011010	26	
21	White x	50	01001101	77	
22	White y	54	01010010	82	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	



27		01	00000001	1 1
28	Standard timing #2	01	0000001	1
	Standard timing #2			
29	Observation to 110	01	00000001	1
2A	Standard timing #3	01	00000001	1
2B		01	00000001	1
2C	Standard timing #4	01	00000001	1
2D		01	00000001	1
2E	Standard timing #5	01	00000001	1
2F		01	00000001	1
30	Standard timing #6	01	00000001	1
31		01	00000001	1
32	Standard timing #7	01	00000001	1
33		01	0000001	1
34	Standard timing #8	01	0000001	1
35		01	00000001	1
36	Pixel Clock/10000 LSB	20	00100000	32
37	Pixel Clock/10000 USB	1C	00011100	28
38	Horz active Lower 8bits	56	01010110	86
39	Horz blanking Lower 8bits	80	10000000	128
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80
3B	Vertical Active Lower 8bits	00	00000000	0
3C	Vertical Blanking Lower 8bits	23	00100011	35
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48
3E	HorzSync. Offset	30	00110000	48
3F	HorzSync.Width	20	00100000	32
40	VertSync.Offset : VertSync.Width	36	00110110	54
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0
42	Horizontal Image Size Lower 8bits	25	00100101	37
43	Vertical Image Size Lower 8bits	A4	10100100	164
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16
45	Horizontal Border (zero for internal LCD)	00	00000000	0
46	Vertical Border (zero for internal LCD)	00	00000000	0
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24
48	Detailed timing/monitor	00	00000000	0
49	descriptor #2	00	00000000	0
4A	•	00	00000000	0
4B		0F	00001111	15
4C		00	00000000	0
4D		00	00000000	0
4E		00	0000000	0
4F		00	0000000	0
50		00	0000000	0
50 51				0
33XW01		00	00000000	1 U



		i	1	1	İ
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5 <b>A</b>	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E	·	00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	33	00110011	51	3
74	Manufacture P/N	33	00110011	51	3
75	Manufacture P/N	58	01011000	88	Х
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	30	00110000	48	0
78	Manufacture P/N	31	00110001	49	1
79	Manufacture P/N	20	00100000	32	
7A	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	33	00110011	51	3
7C		20	00100000	32	



7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	0F	10110110	182	

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